SN54ALS323, SN74ALS323 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS WITH SYNCHRONOUS CLEAR AND 3-STATE OUTPUTS

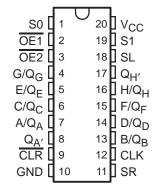
SDAS267A - DECEMBER 1982 - REVISED DECEMBER 1994

- Multiplexed I/O Ports Provide Improved Bit Density
- Four Modes of Operation:
 - Hold (Store)
 - Shift Right
 - Shift Left
 - Load Data
- Operate With Outputs Enabled or at High Impedance
- 3-State Outputs Drive Bus Lines Directly
- Can Be Cascaded for n-Bit Word Lengths
- Synchronous Clear
- Applications:
 - Stacked or Push-Down Registers
 - Buffer Storage
 - Accumulator Registers
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

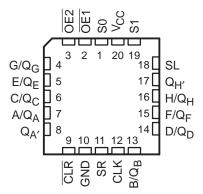
description

These 8-bit universal shift/storage registers feature multiplexed input/output (I/O) ports to achieve full 8-bit data handling in a 20-pin package. Two function-select (S0, S1) inputs and two output-enable (OE1, OE2) inputs can be used to choose the modes of operation listed in the function table.

SN54ALS323 . . . J PACKAGE SN74ALS323 . . . DW OR N PACKAGE (TOP VIEW)



SN54ALS323 . . . FK PACKAGE (TOP VIEW)



Synchronous parallel loading is accomplished by taking both S0 and S1 high. This places the 3-state outputs in the high-impedance state and permits data applied on the I/O ports to be clocked into the register. Reading out of the register can be accomplished while the outputs are enabled in any mode. Clearing occurs synchronously when the clear (CLR) input is low. Taking either OE1 or OE2 high disables the outputs but has no effect on clearing, shifting, or storing data.

The SN54ALS323 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ALS323 is characterized for operation from 0°C to 70°C.

SN54ALS323, SN74ALS323 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS WITH SYNCHRONOUS CLEAR AND 3-STATE OUTPUTS

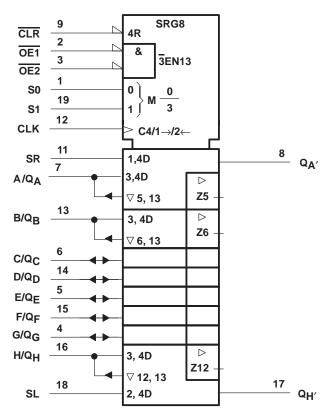
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FUNCTION TABLE

MODE				INP	UTS							I/O P	ORTS				OUTI	PUTS
MODE	CLR	S1	S0	OE1†	OE2†	CLK	SL	SR	A/Q _A	B/QB	C/QC	D/QD	E/Q _E	F/Q _F	G/Q _G	H/Q _H	$Q_{A'}$	$Q_{H'}$
Clear	L L L	X L H	L X H	L L X	L L X	↑ ↑	X X X	X X X	L L X	L L L	L L L							
Hold	H H	L X	L X	L L	L L	X L	X X	X X	Q _{A0} Q _{A0}	Q _{B0} Q _{B0}	QC0	Q _{D0} Q _{D0}	Q _{E0} Q _{E0}	Q _{F0} Q _{F0}	Q _{G0} Q _{G0}	Q _{H0} Q _{H0}	Q _{A0} Q _{A0}	Q _{H0} Q _{H0}
Shift Right	H H	L L	H H	L L	L L	↑ ↑	X X	H L	H L	Q _{An} Q _{An}	Q _{Bn} Q _{Bn}	Q _{Cn} Q _{Cn}	Q _{Dn} Q _{Dn}	Q _{En} Q _{En}	Q _{Fn} Q _{Fn}	Q _{Gn} Q _{Gn}	H L	Q _{Gn} Q _{Gn}
Shift Left	H H	H H	L	L L	L L	↑	H L	X X	Q _{Bn} Q _{Bn}	Q _{Cn}	Q _{Dn} Q _{Dn}	Q _{En} Q _{En}	Q _{Fn} Q _{Fn}	Q _{Gn} Q _{Gn}	Q _{Hn} Q _{Hn}	H L	Q _{Bn} Q _{Bn}	H
Load	Н	Н	Н	Χ	Χ	1	Χ	Χ	а	b	С	d	е	f	g	h	а	h

NOTE: a . . . h = the level of the steady-state input at inputs A through H, respectively. This data is loaded into the flip-flops while the flip-flop outputs are isolated from the I/O terminals.

logic symbol‡



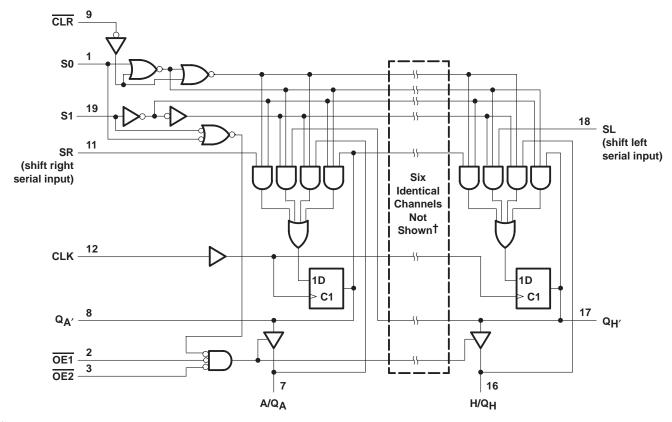
[‡] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



[†] When one or both output-enable inputs are high, the eight I/O terminals are disabled to the high-impedance state; however, sequential operation or clearing of the register is not affected.

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logic diagram (positive logic)



 \dagger I/O ports not shown: B/QB (13), C/QC (6), D/QD (14), E/QE (5), F/QF (15), and G/QG (4).

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V _{CC}	7 V
Input voltage, V _I : All inputs	7 V
I/O ports	5.5 V
Operating free-air temperature range, T _A : SN54ALS323	–55°C to 125°C
SN74ALS323	0°C to 70°C
Storage temperature range	65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

SN54ALS323, SN74ALS323 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS WITH SYNCHRONOUS CLEAR AND 3-STATE OUTPUTS

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recommended operating conditions

				SN54ALS323			SN	LINUT		
				MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage			4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage			2			2			V
VIL	Low-level input voltage					0.7			0.8	V
	I Park Terral and and annual	Q _A ' or Q _H '				-0.4			-0.4	4
IОН	High-level output current	Q _A thru Q _H				-1			-2.6	mA
		Q _A ′ or Q _H ′				4			8	4
lOL	Low-level output current	Q _A thru Q _H				12			24	mA
TA	Operating free-air temperature			-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TF0T 00	SN	54ALS3	23	SN					
		TEST CC	MIN	TYP [†]	MAX	MIN	TYP†	MAX	UNIT		
		V _{CC} = 4.5 V,	$I_{I} = -18 \text{ mA}$			-1.5			-1.5	V	
	Any output	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2	2		V _{CC} -2	2			
Vон	O . thru O .	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	$I_{OH} = -1 \text{ mA}$	2.4	3.3					V	
	Q _A thru Q _H	V _{CC} = 4.5 V	$I_{OH} = -2.6 \text{ mA}$				2.4	3.2			
	007.0	\\ 45\\	$I_{OL} = 4 \text{ mA}$		0.25	0.4		0.25	0.4		
11/	Q _A ' or Q _H '	V _{CC} = 4.5 V	$I_{OL} = 8 \text{ mA}$					0.35	0.5	5 V	
V _{OL}	O . thomas O .	\\ 45\\	$I_{OL} = 12 \text{ mA}$		0.25	0.4		0.25	0.4	\ \	
	Q _A thru Q _H	V _{CC} = 4.5 V	I _{OL} = 24 mA				0.35		0.5		
	A thru H		V _I = 5.5 V			0.1			0.1	^	
I _I	Any others	V _{CC} = 5.5 V	V _I = 7 V		0.1				0.1	mA	
I _{IH} ‡		V _{CC} = 5.5 V,	V _I = 2.7 V			20			20	μΑ	
. +	S0, S1, SR, SL	V 55V				-0.2			-0.2		
I _{IL} ‡	Any others	$V_{CC} = 5.5 \text{ V},$	$V_{ } = 0.4 \text{ V}$		-0.1				-0.1	mA	
Q _A ' or Q _H '		.,	.,	-15		-70	-15		-70		
los§	Q _A thru Q _H	V _{CC} = 5.5 V,	$V_0 = 2.25 \text{ V}$	-20		-112	-30		-112	mA	
			Outputs high		15	28		15	28		
ICC		V _{CC} = 5.5 V	Outputs low		22	38		22	38	mA	
			Outputs disabled		23	40		23	40		

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

For I/O ports (Q_A thru Q_H), the parameters I_{IH} and I_{IL} include the off-state output current.

[§] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

SN54ALS323, SN74ALS323 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS WITH SYNCHRONOUS CLEAR AND 3-STATE OUTPUTS SDAS267A - DECEMBER 1982 - REVISED DECEMBER 1994

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

				SN54A	SN54ALS323		SN74ALS323		
				MIN	MAX	MIN	MAX	UNIT	
fclock	f _{clock} Clock frequency (at 50% duty cycle)						17	MHz	
t _W	Pulse duration	CLK high or low	22		16.5		ns		
		S0 or S1	25		20				
		Carial as sampled data	High	18		16			
t _{su}	Setup time before CLK↑	Serial or parallel data		15		6		ns	
		CLR active	25		20				
	Inactive-state setup time before CLK↑†	CLR		18		16			
	Hold time after CLK↑	S0 or S1	0		0				
th	Hold time after CLK	Serial or parallel data	0		0		ns		

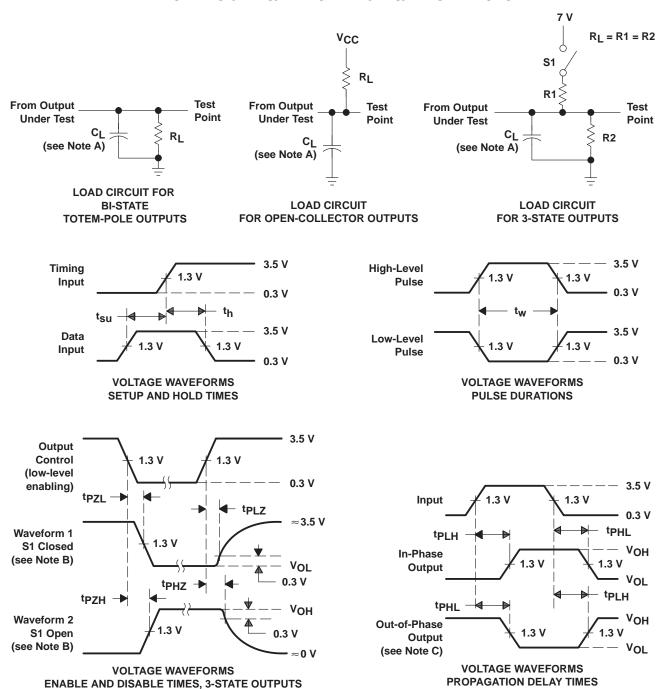
[†] Inactive-state setup time is also referred to as recovery time.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	CL R1 R2 T _A	V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R1 = 500 Ω, R2 = 500 Ω, T_A = MIN to MAX [‡]				
			SN54A		SN74ALS323			
			MIN	MAX	MIN	MAX		
f _{max}			17		17		MHz	
t _{PLH}	CLK	Q _A thru Q _H	2	19	4	13	ns	
tPHL the transfer of the trans	OLK	α _A mu α _H	4	25	7	19		
t _{PLH}	CLK	Q _{A′} or Q _{H′}	2	21	5	15	20	
t _{PHL}	OLK	QA' OI QH'	4	25	8	18	ns	
^t PZH	OE1, OE2	O . thru Ou	5	22	6	16		
^t PZL	OE1, OE2	Q _A thru Q _H	6	27	8	22	ns	
^t PZH	CO C1	O . thru O	5	27	7	17	20	
t _{PZL}	S0, S1	Q _A thru Q _H	6	27	8	22	ns	
^t PHZ	OE1, OE2	O . thru O .	1	15	1	8		
^t PLZ	OE1, OE2	Q _A thru Q _H	4	38	5	15	ns	
^t PHZ	SO 51	On thru Ou	1	16	1	12	ns	
^t PLZ	S0, S1	Q _A thru Q _H	4	34	8	25	119	

[‡] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, $t_{\Gamma} = t_{f} = 2$ ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms







www.ti.com 5-Sep-2011

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
83021022A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Call TI	
8302102RA	ACTIVE	CDIP	J	20	1	TBD	Call TI	Call TI	
8302102SA	ACTIVE	CFP	W	20	1	TBD	Call TI	Call TI	
SN74ALS323N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	
SN74ALS323N3	OBSOLETE	PDIP	N	20		TBD	Call TI	Call TI	
SN74ALS323NE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	
SNJ54ALS323FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	
SNJ54ALS323J	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	
SNJ54ALS323W	ACTIVE	CFP	W	20	1	TBD	Call TI	N / A for Pkg Type	

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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5-Sep-2011

OTHER QUALIFIED VERSIONS OF SN54ALS323, SN74ALS323:

• Military: SN54ALS323

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

• Military - QML certified for Military and Defense Applications

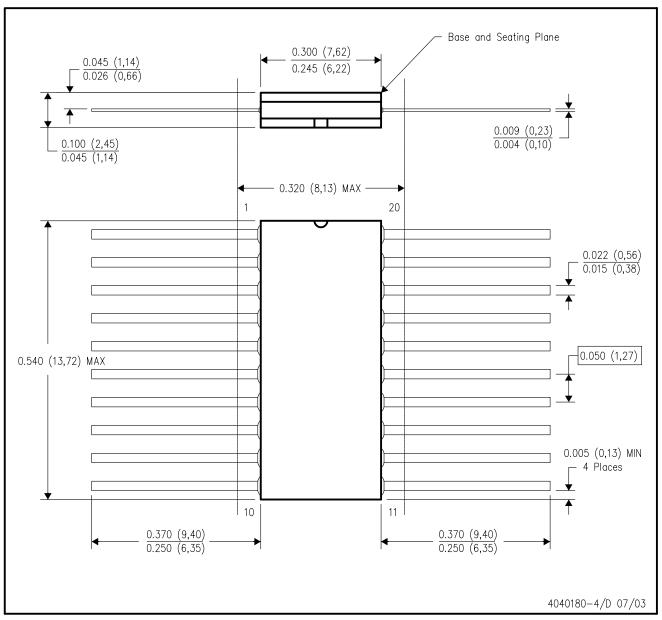
14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within Mil-Std 1835 GDFP2-F20



FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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